



E-tec Interconnect AG is the world leading Test socket manufacturer

Probe Pin (Pogo) Solderless compression Test Sockets type are available for any chip size and pitch and are attached with 2, 4 or 8 screws to the PCB. The assembly board ensures perfect coplanarity of the socket. Contact reliability is guaranteed with spring loaded gold plated contacts, which are pressed onto gold plated PCB pads. Probe Pin (Pogo) Solderless compression type sockets are available with all retention systems. We aim to solve your requirements. Please note, we will always request the chip data to ensure we offer a compatible socket.

	Contacts Specifications				
	Contact type code	0490	0491	0492	0494
	Application	Standard	Frequency	High Frequency	High Power
cifications contact ty ng	mounting	Solderless	Solderless	Solderless	Solderless
	Bandwidth (GHz@-18dB)	3 GHz	10 GHz	20 GHz	na
	Contact resistance	<100 mOhm	100 mOhm	100 mOhm	100 mOhm
o or Concave tip	Chipecontact tip shapeto +150	°cSingle Point tip	Single Point tip	Single Point tip	Crown tip
	PCB tip shape	Spring	Single Point tip	Single Point tip	Single Point tip
	Force	20 gr	20 gr	20 gr	30 gr
	Current rating	0.5 A	1.5 A	1.5 A	3 A
	Capacitance pF	<1pF	0.90 pF	0.50 pF	na
	Inductance nH	<2nH	1.50 nH	1.20 nH	na
	Impedance Ohms	45 Ω	48 Ω	42 Ω	na
	Temperature range	-55°C to +150°C	-40°C to +120°C	-40°C to +120°C	-40°C to +120°C
	Mating cycles	100 K	300 K	100 K	100 K

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